

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
BV _{DSS}	Drain-to-Source Breakdown Voltage	400			V	$V_{GS} = 0V, I_{D} = 1.0mA$	
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.46		V/°C	Reference to 25°C, I _D = 1.0mA	
R _{DS(on)}	Static Drain-to-Source On-Resistance			1.00	Ω	V _{GS} = 10V, I _{D2} = 3.5A ④	
				1.22		V _{GS} = 10V, I _{D1} = 5.5A ④	
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
I _{DSS}	Zero Gate Voltage Drain Current			25	μA	$V_{DS} = 320V, V_{GS} = 0V$	
				250		$V_{DS} = 320V, V_{GS} = 0V, T_{J} = 125^{\circ}C$	
I_{GSS}	Gate-to-Source Leakage Forward			100	nA	V _{GS} = 20V	
	Gate-to-Source Leakage Reverse			-100	ш	V _{GS} = -20V	
Q_G	Total Gate Charge	17		39		$I_{D1} = 5.5A$	
Q_{GS}	Gate-to-Source Charge	2.0		6.0	nC	V _{DS} = 200V	
Q_{GD}	Gate-to-Drain ('Miller') Charge	8.0		20		V _{GS} = 10V	
t _{d(on)}	Turn-On Delay Time			30		V _{DD} = 200V	
tr	Rise Time			40	ns	$I_{D1} = 5.5A$	
$t_{d(off)}$	Turn-Off Delay Time			80	115	$R_G = 7.5\Omega$	
t _f	Fall Time			35		V _{GS} = 10V	
Ls +L _D	Total Inductance		6.1		n⊔	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package)	
C _{iss}	Input Capacitance		620			V _{GS} = 0V	
C _{oss}	Output Capacitance		200		pF	V _{DS} = 25V	
C _{rss}	Reverse Transfer Capacitance		75			f = 1.0MHz	

Source-Drain Diode Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
I _S	Continuous Source Current (Body Diode)			5.5	۸		
I _{SM}	Pulsed Source Current (Body Diode) ①			22	Α		
V_{SD}	Diode Forward Voltage			1.4	V	$T_J = 25^{\circ}C, I_S = 5.5A, V_{GS} = 0V$	
t _{rr}	Reverse Recovery Time			700	ns	$T_J = 25^{\circ}C, I_F = 5.5A, V_{DD} \le 30V$	
Q _{rr}	Reverse Recovery Charge			6.2	μC	di/dt = 100A/µs ④	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)					

Thermal Resistance

Symbol	Parameter	Min.	Тур.	Max.	Units	
$R_{\theta JC}$	Junction-to-Case			1.67	°C/W	
$R_{ heta JA}$	Junction-to-Ambient (Typical socket mount)			30	- C/VV	

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$ V_{DD} = 50V, starting T_J = 25°C, L= 0.11mH, Peak I_L = 5.5A, V_{GS} = 10V.
- $\ \ \, 3$ $\ \ \, I_{SD} \ \le \ 5.5A, \, di/dt \ \le \ 90A/\mu s, \, V_{DD} \le \ 400V, \, T_J \le 150^{\circ}C.$ Suggested R_G =7.5 Ω

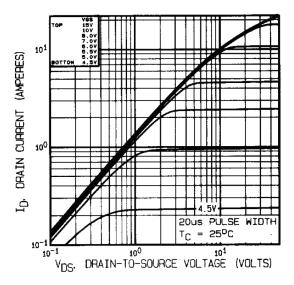


Fig 1. Typical Output Characteristics

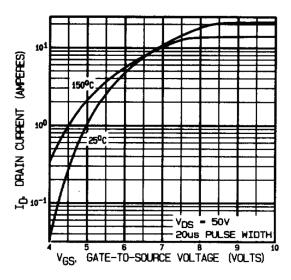


Fig 3. Typical Transfer Characteristics

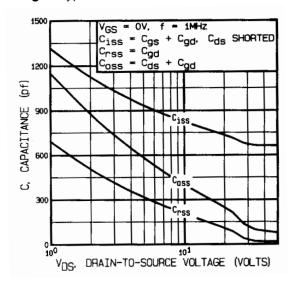


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

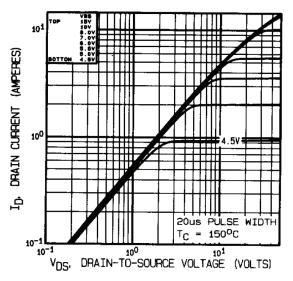


Fig 2. Typical Output Characteristics

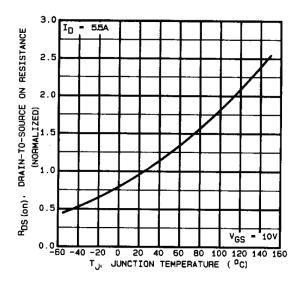


Fig 4. Normalized On-Resistance Vs. Temperature

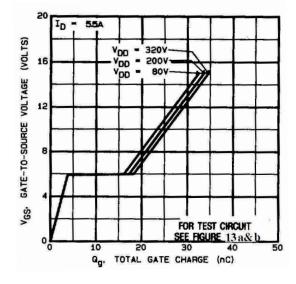


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

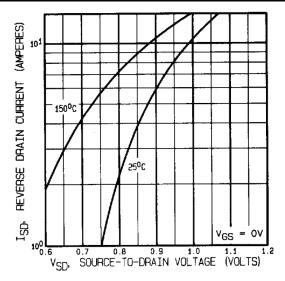


Fig 7. Typical Source-Drain Diode Forward Voltage

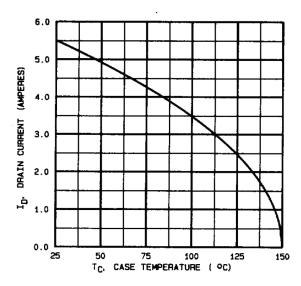


Fig 9. Maximum Drain Current Vs. Case Temperature

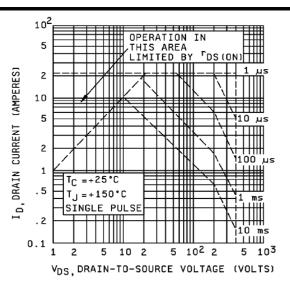


Fig 8. Maximum Safe Operating Area

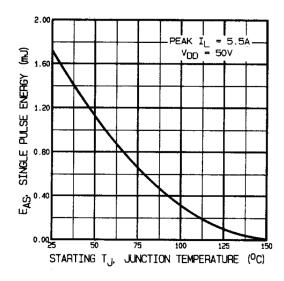


Fig 10. Maximum Avalanche Energy Vs. Drain Current

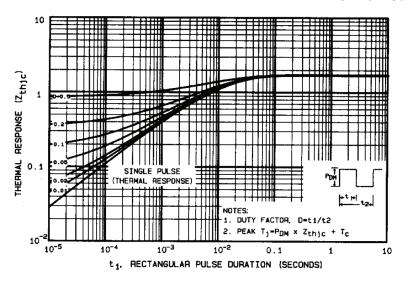


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

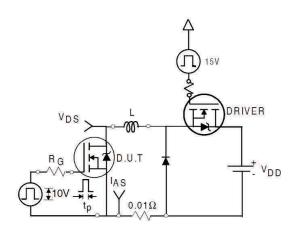


Fig 12a. Unclamped Inductive Test Circuit

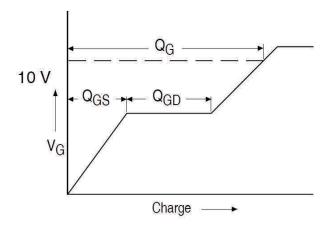


Fig 13a. Gate Charge Waveform

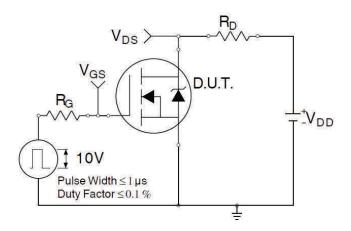


Fig 14a. Switching Time Test Circuit

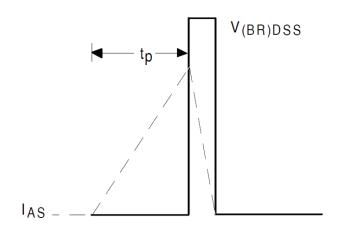


Fig 12b. Unclamped Inductive Waveforms

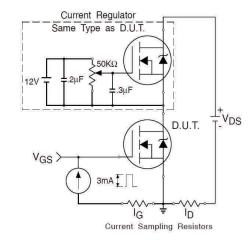


Fig 13b. Gate Charge Test Circuit

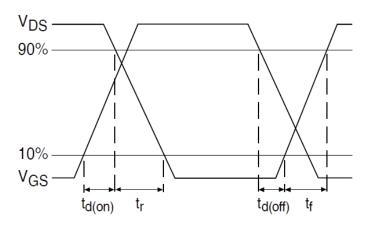
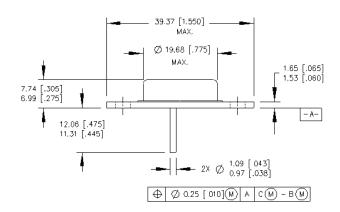
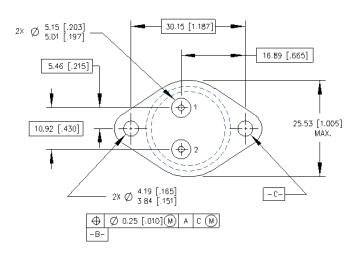


Fig 14b. Switching Time Waveforms



Case Outline and Dimensions - TO-204AA (Modified TO-3)





PIN ASSIGNMENTS

HEXFET SCHOTTKY <u>IGBT</u> 1 - SOURCE 1 - ANODE 1 1 - GATE 2 - GATE 3 - DRAIN (CASE) 2 - EMITTER 3 - COLLECTOR (CASE) 2 - ANODE 2 3 - COMMON CATHOD (CASE)

NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILIMETERS [INCHES]
 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO -204-AA



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